



(51) International Patent Classification:

A61K 8/365 (2006.01) A61K 31/19 (2006.01)
A61P 17/00 (2006.01) A61Q 5/00 (2006.01)
A61K 8/06 (2006.01) A61Q 19/00 (2006.01)
A61K 8/11 (2006.01) A61Q 19/10 (2006.01)

(21) International Application Number:

PCT/MY2020/000020

(22) International Filing Date:

18 November 2020 (18.11.2020)

(25) Filing Language:

English

(26) Publication Language:

English

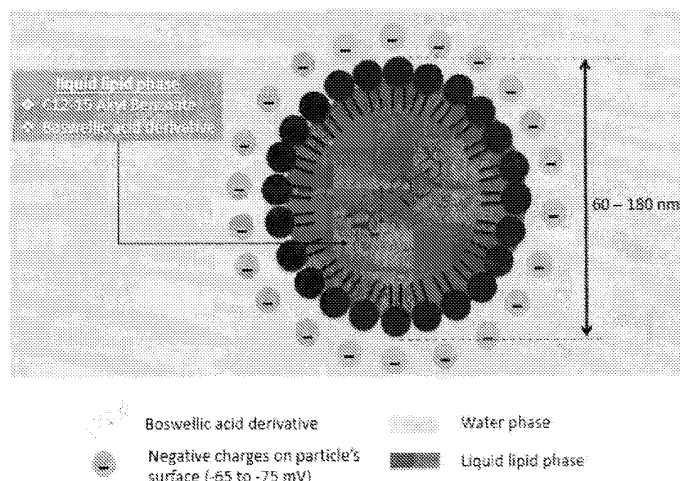
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(54) Title: METHOD AND COMPOSITIONS FOR SKIN MICROBIOME NORMALIZATION IN SENSITIVE SKIN

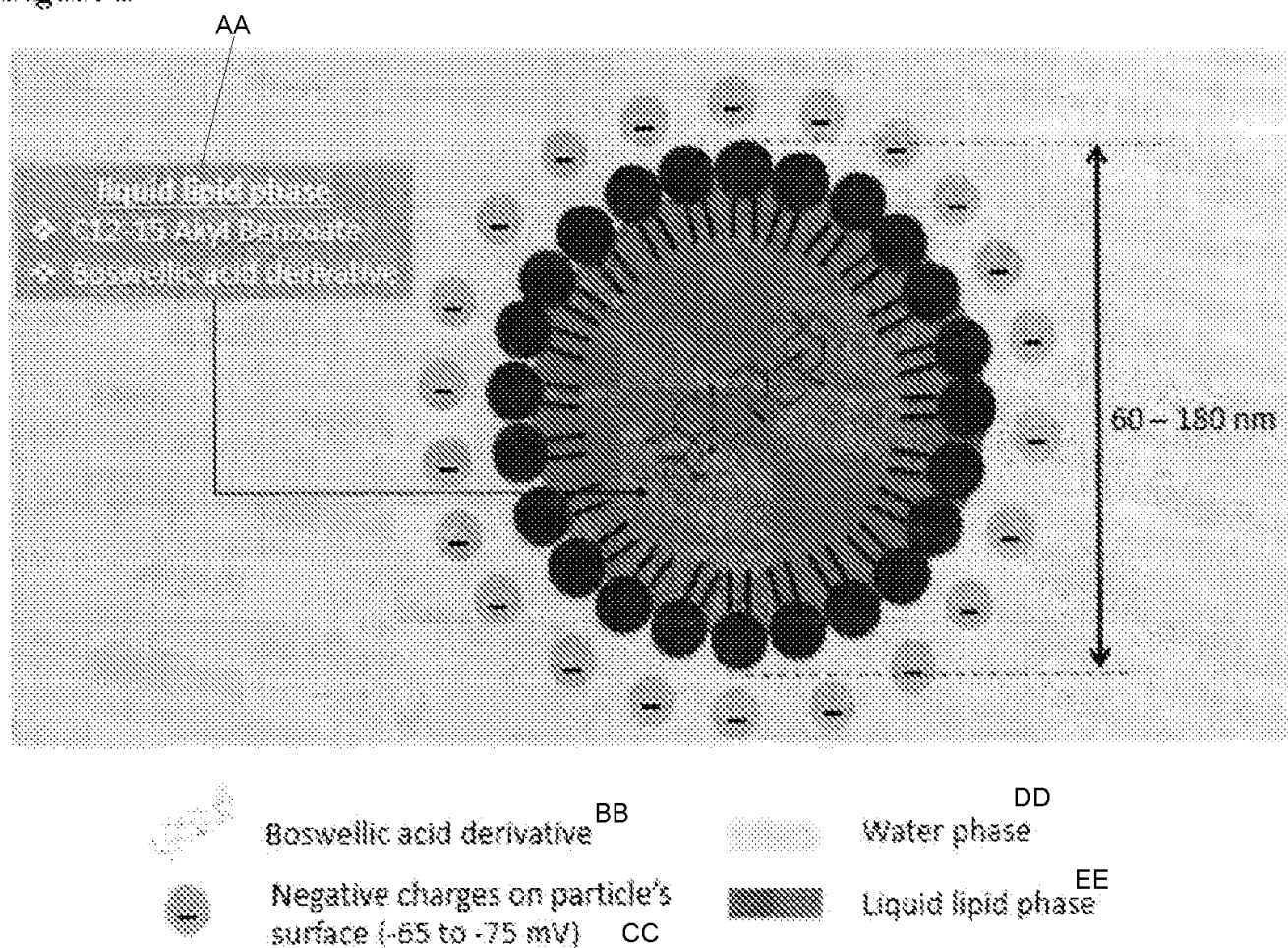
Figure 2



(57) Abstract: The present invention relates to compositions comprising boswellic acid, one or more derivatives of boswellic acid, or a mixture thereof, that are stabilized via encapsulation in a nanoemulsion having a liquid lipid core and a negative surface charge. Uses of the compositions in treating the subclinical symptoms of sensitive skin by modulating the growth of sensitive skin causing bacteria. The present invention also provides methods of microbiome normalization and improving skin condition, especially for the population with sensitive skin.

[Continued on next page]

Figure 2



AA ... phase lipidique liquide / benzoate d'alkyle en C12-C15 / dérivé de l'acide boswellique

BB ... Dérivé de l'acide boswellique

DD ... Phase aqueuse

CC ... Charges négatives à la surface de la particule (de -65 à -75 mV)

EE ... Phase lipidique liquide